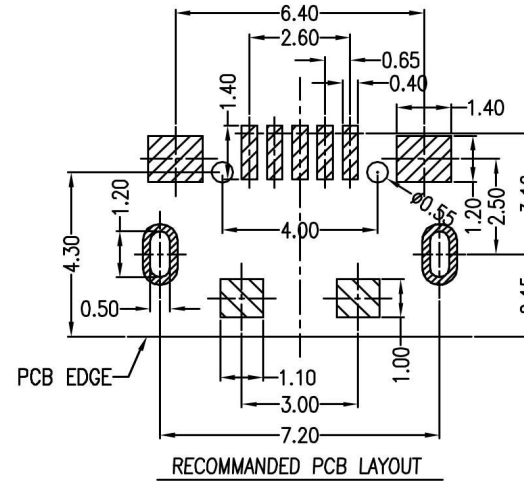
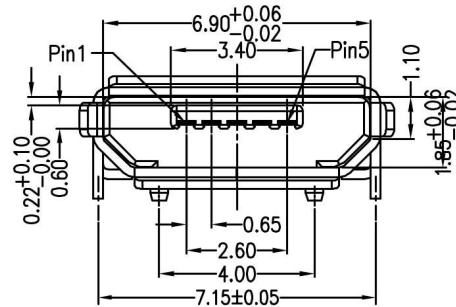
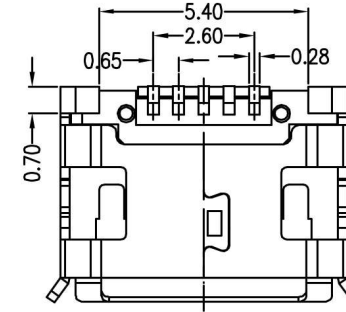
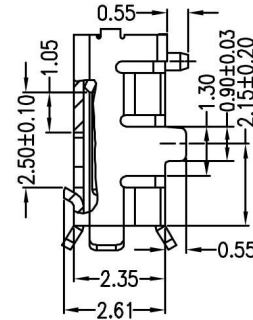
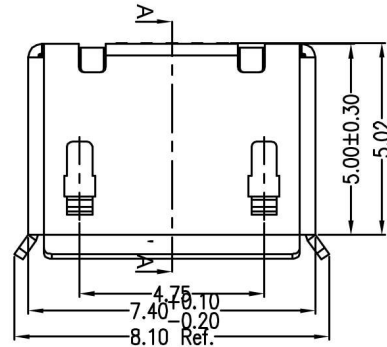
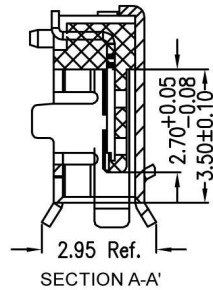
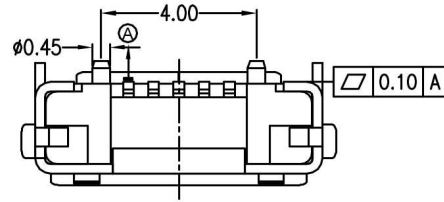


Kinghelm®



Note:

1.Material:

- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.20mm
- 1.3 Shell: copper alloy,t=0.25mm

2.Specification:

- 2.1 Current rating: 1 A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 50 mW Max.
- 2.4 Insulation resistance: 100 MW Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.0.81~2.05 Kgf Min.after 10000 insertion/extraction cycles
- 2.7 Temperature range: -30°C~80°C

A 01 S B X X X X X X X 1-047
① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪ ⑫ ⑬

1. Part No.	A:Finished product	6.Housing	Electroplating	0:鍍銀;1:100μ"2:鍍金100μ"3:鍍Ni+Au"4:鍍金"5:鍍金"
2.Product series	01:micro usb spin	7.Terminal Material	4:05191R-EH 2:02680R-EH	11.Packaging method
3.Product category	s:Receptacle	8.Terminal Plating	0:鍍銀;1:鍍金"2:鍍金100μ"3:鍍Ni+Au"4:鍍金"5:鍍金"	12.Type of lower plate
4.Product type	B:B TYPE	9.Body material	1:ULP	13.Detail flow
5.Housing Material	1:C2680R-H	10.Body color	B:Black W:White	017:Micro USB 5S B TYPE 兩腳全插(牛角型)插針

PART NO:	A01SB1X3X1BX1-047	MATERIAL:	SEE NOTE	SHENZHEN KINGHELM ELECTRONIC CO., LTD.	WWW.BDS666.COM
MODEL NO:	XX	FINSH:	SEE NOTE	Model:	(H-MICRO-SMT.J7.2-5P) 0755-83044319
UNIT:	MM	SIZE:	A4	COLOR:	SEE NOTE
TOLERANCE	UNSPECIFIED	DR:	夏友紅	TITLE:	Housing DIP 7.2 with guide position and columns
.x	0.25	CHK:		DWG NO:	A047
.xx	0.20	APP:		SCALE:	5:1
.xxx	0.15			DATE:	2012.05.21
Ang.	2'				

